



Stochastic Dynamic Thermal Management: *A Markovian Decision-based Approach*

Hwisung Jung, Massoud Pedram

University of Southern California

Outline

- Introduction
- Background
- Thermal Management Framework
 - Accuracy of Modeling
 - Policy Representation
- Stochastic Dynamic Thermal Management
 - SDTM Algorithm
 - Multi-objective Design Optimization
- Experimental Result
- Conclusions

Introduction

- "Smaller and faster" translate into high power densities, higher operating temperature, and lower circuit reliability.
- Local Hot Spots are becoming more prevalent in VLSI circuits.
- It is no longer sufficient to merely add a bigger fan as a downstream fix for thermal problems.
- Thermal managements need to be best accomplished when it is incorporated starting at the beginning of the design cycle.
- Any applications that generate heat should engage in runtime thermal management technique, i.e., *dynamic thermal management*.

Prior Work

- K. Skadron, et al. : architectural-level thermal model, *HotSpot*, (*ISCA 2003*)
- D. Brooks, et al. : trigger mechanism (*HPCA 2001*).
- J. Srinivasan, et al. : predictive DTM (*Int'l Conf. on Supercomputing* 2003)
- S. Gurumurthi, et al. : performance optimization problem for disk drives (SIGARCH 2005)

■ For a good survey, see P. Dadvar, et al. (*Semi-Therm Symp. 2005*)

Motivation

- The above-mentioned DPM techniques have difficulty observing the peak power dissipation on the chip because they rely on a single temperature sensor, whereas the peak temperature may appear in a number of different places on the chip. This gives rise to uncertainty about the true temperature state of a chip.
- Improving the accuracy of decision making in thermal management by modeling and assessing the *uncertainty* in temperature observation is an important step to guarantee the quality of electronics.
- Develop a stochastic thermal management framework, based on
 - Partially observable Markov decision process (POMDP)
 - Semi-Markov decision process (SMDP)
- Combine DTM and DVFS to control temperature of system and its power dissipation.

Uncertainty

- Critical problems in temperature profile characterization are:
 - Placement restriction for the on-chip temperature sensor
 - Non-uniform temperature distribution across the chip.
- This causes uncertainty in the temperature observation.



Example of non-uniform temperature distribution

Stochastic Process Model

- The uncertainty problem, where a thermal manager cannot reliably identify the thermal state of the chip, can be solved by modeling decision making by a stochastic process.
- A thermal manager observes the overall thermal state and issues commands (i.e., actions) to control the evolution of the thermal state of the system.
- These actions and thermal states determine the next-state probability distribution over possible next steps.



 The sequence of thermal states of the system can be modeled as a stochastic process.

Thermal Management Framework

- SMDP to model event-driven decision making.
- POMDP to consider the uncertainty in temperature observation.

Note: The time spent in a particular state in the SMDP follows an arbitrary distribution, realistic assumption than an exponential distribution.

- Definition 1: Partially Observable Semi-Markov Decision Process.
 A POSMDP is a tuple (*S, A, O, T, R, Z*) such that
 - 1) S is a finite set of states.
 - 2) A is a finite set of actions.
 - 3) O is a finite set of observations.
 - 4) *T* is a transition probability function. *T*: $S \times A \rightarrow \Delta(S)$
 - 5) *R* is a reward function. *R*: $S \times A \rightarrow \mathcal{R}$
 - 6) *Z* is an observation function. *Z*: $S \times A \rightarrow \Delta(Z)$

where $\Delta(\cdot)$ denotes the set of probability distributions.

POSMDP By Way of an Example



POSMDP framework for dynamic thermal management

Full History

- In an observable environment, observations are probabilistically dependent on the underlying chip temperature.
- Transition probability function determines the probability of a transition from thermal state s to s' after executing action a

$$T(s', a, s) = Prob(s^{t+1} = s' | a^t = a, s^t = s)$$

 Observation function captures the relationship between the actual state and the observation.

$$Z(o', s', a) = Prob(o^{t+1} = o' | a^{t} = a, s^{t+1} = s')$$

 Since thermal manager cannot fully observe the thermal state of the system, it makes decisions based on the observable system history.



Relying on the full history <s⁰, a⁰>, <s¹, a¹>,...,<s^t, a^t> makes the decision Process *non-Markovian*, which is not desirable.

How to Avoid Reliance on Full History

Although the observation gives the thermal manager some evidence about the current state s, s is not exactly known.

We maintain a distribution over states, called a belief state *b*.

The belief state (vector) for state s is denoted as b(s); Given any actual state, the sum of belief state probabilities over all belief states is equal to 1.



Note: Even though we know the action, the observation is not known in advance since the observations are probabilistic.

Markovian Property

By using the state space B, a properly updated probability distribution over the thermal state S, we can convert the original history-based decision making into into a fully observable SMDP.

$$b'(s') = \frac{\sum_{s \in S} Prob(s', o \mid s, a)b(s)}{\sum_{s \in S} \sum_{s' \in S} Prob(s', o \mid s, a)b(s)}$$

The process of maintaining the belief state is Markovian, where the belief state SMDP problem can be solved by adapting the value iteration algorithms.



Thermal Management Framework

- Thermal manager's goal is to choose a policy that minimizes a cost.
- Let $\pi: B \to A$ represent a stationary policy that maps probability distribution over states to actions.
- By incorporating expectation over actions, the set of stationary policies can be determined by using Bellman equation

$$C^{\pi}(b) = \sum_{s \in S} b(s)k(s, a) + \gamma \sum_{o \in O} \sum_{s' \in S} Z(o, s', a) \sum_{s \in S} T(s', a, s) C^{\pi}(b')$$

• The optimal action to take in *b* is obtained by

$$\pi^*(b) = \arg\min_{a\in A} C^{\pi}(b)$$

Stochastic DTM

A stochastic dynamic thermal management based on POSMDP.



- Definition 2: Observation strategy. In policy tree, an observation strategy is defined as $\psi: O \rightarrow \Lambda$ such that
 - 1) O is a finite set of observations

2)
$$\Lambda = \{(a, \psi) \mid a \in A, \psi \in \Lambda_{o}\}$$

where A is a finite set of actions, and Λ_{o} is a finite set of all policy trees.

Stochastic DTM

- A multi-objective design optimization method is used to optimize the performance metrics by formulating mathematical programming model.
- Let a sequence of belief states b⁰, b¹,..., bⁿ denote a processing path δ from b⁰ to bⁿ of length n.
- For a policy π , the discounted cost C of a processing path δ of length *n* is defined as

$$C^{\pi}(\delta) \square \sum_{i=0}^{n} \gamma^{t_i} cost(b^i, a^i)$$

where t^i denotes the duration of time that the system spends in belief state b^i before action a^i causes a transition to state b^{i+1} , and

$$cost(b,a) = pow(b) + \frac{1}{\tau(b,a)} \sum_{b' \in B} Prob(b' \mid b,a)ene(b,b')$$

- *pow(b)* is the power consumption of the system in belief state *b*
- *Prob(b' | b, a)* is the probability of being in state *b'* after action *a* in state *b*
- ene(b, b') is the energy required by the system to transit from state b to b'
- $\tau(b, a)$ is the expected duration of time that system spent in b when action a

Stochastic DTM

 Considering the expectation with respect to the policy over the set of processing paths starting in state b, the expected cost of the system is

$$pow_{avg}^{\pi}(b) = EXP[C^{\pi}(\delta)]$$

The design objective is a vector *J* of performance metrics we are trying to optimize, where the design vector *a* contains DVFS set.



Note: $\chi(b, a)$ is the frequency that the system is in thermal state b and action a is issued.

- For experimental setup, a 32bit RISC processor is designed in 0.18um technology, and stochastic framework is implemented in Matlab.
- In the first experiment, we analyzed power dissipation distribution of RISC.

SPECint 2000	BOUT	ese Unes	· 1, 1, 100	·mei	TUI	Shifter	êl,	ŝ	in the second	decode	, tetill	etecit	e cul
gcc	4.6%	14.4%	13.8%	4.1%	2.3%	2.7%	16.5%	2.2%	15.4%	4.1%	4.1%	4.1%	11.7%
gap	4.3%	13.1%	15.7%	4.0%	4.2%	3.1%	14.2%	1.7%	14.8%	4.2%	4.2%	4.2%	12.3%
gzip	4.6%	9.2%	15.4%	4.6%	4.5%	3.8%	18.6%	2.3%	15.1%	4.6%	4.6%	4.6%	8.1%



Power simulation flow

- The second experiment is to demonstrate the effectiveness of our proposed SDTM algorithm.
 - Randomly choose a sequence of 40 program, e.g., $gcc_1-gzip_2-gap_3-\ldots-gcc_{39}-gcc_{40}$.
 - The sequence of programs is executed on the RISC.
 - Calculate the belief state.



Action	Decemintion	cost	State,	Description	
Action	Description	$[k(s_1, a) k(s_2, a) k(s_3, a)]$	Observation		
<i>a</i> ₁	[1.65V/200MHz]	[1.5 1 0]	s_1 , o_1	$[50^{\circ}C \le temp < 65^{\circ}C]$	
<i>a</i> ₂	[1.80V/350MHz]	[1 0 1]	s ₂ , o ₂	$[65^{\circ}C \le temp < 75^{\circ}C]$	
<i>a</i> ₃	[1.95V / 500MHz]	[0 1 1.5]	s ₃ , o ₃	$[75^{\circ}C \le temp < 90^{\circ}C]$	

Operating temperature of the RISC by running the sequence.



Average temperature for test scenario

Note: the average temperature is estimated based on $T_{chip} = T_a + \theta_{ja} (P_{s/w} + P_{s/c} + P_{static} + P_{int})$

 A low value on the action axis means low supply voltage and low frequency Values of possible target actions, are obtained by multiobjective optimization

	1.95V/500MHz	1.80V/350MHz	1.65V/200MHz	SDTM
Average power	1.00	0.85	0.72	0.75
Throughput	1.00	0.69	0.40	0.69
Energy/operation	1.00	1.23	1.79	1.08

Achieve low power consumption and operating temperature with little performance Impact on throughput and energy/operation metrics.

Conclusion

- Proposed a stochastic dynamic thermal management technique by providing stochastic management framework to improve the accuracy of decision making.
- POSMDP-based thermal management controls the thermal states of the system and makes a decision (DVFS set) to reduce operating temperature.
- Experimental results with design optimization formulations demonstrate the effectiveness of our algorithm (low temperature with little impact on performance metrics).

Thank You !!

Yet Another Example

A scenario where starting with an action a₂ issued at time *t*, the next system state may be one of three possible ones as observed at time *t*+1.



- Case a: the system remains in the active mode with steady workload, resulting in the same chip temperature.
- Case b: the system remains in the active mode, but heavy workload, resulting in temperature increase.
- Case c: the system enters into the idle mode.

Backup Slide

Given CPU benchmark SPECint 2000 such as gcc, gap, and gzip with following characteristics,

program # of ints. (in Million) gcc 6765 gap 12726 gzip 75942

Calculate the CPI and total execution time.

For example, in gcc,

Operation	Freq.	Cycle	CPI	%
ALU	40%	1	40x1/100 = 0.4	0.4/1.4 = 25%
Load	35%	2	35x2/100 = 0.7	0.7/1.6 = 43%
Store	10%	2	10x2/100 = 0.2	0.2/1.6 = 13%
Branch	15%	2	15x2/100 = 0.3	0.3/1.6 = 19%

Total CPI = 1.6

CPU time = Inst/program x cycles/Inst x second/cycle = I x CPI x C = 6765 x 1.6 x 2ns (500MHz) = 21648